



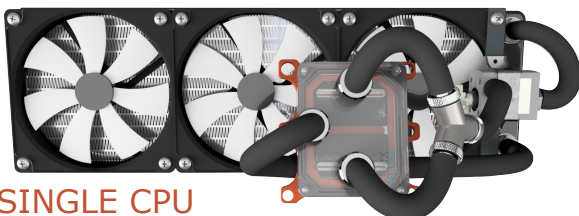
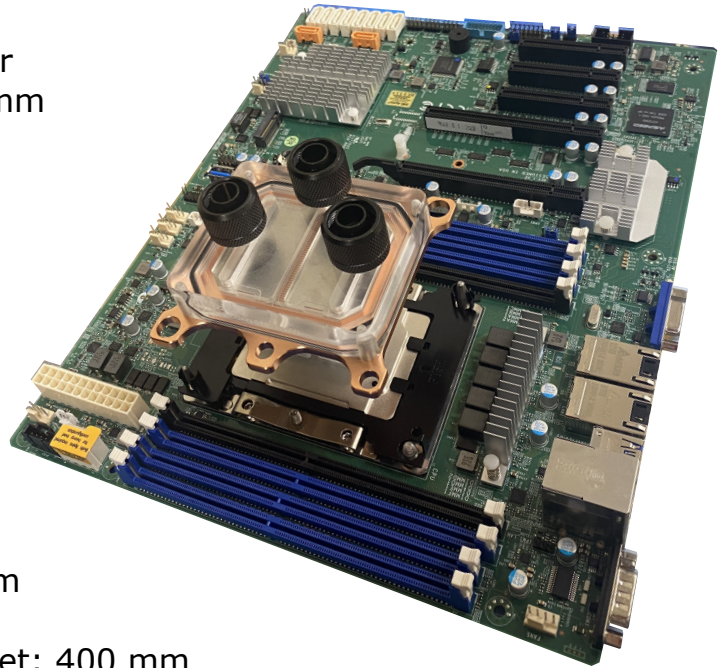
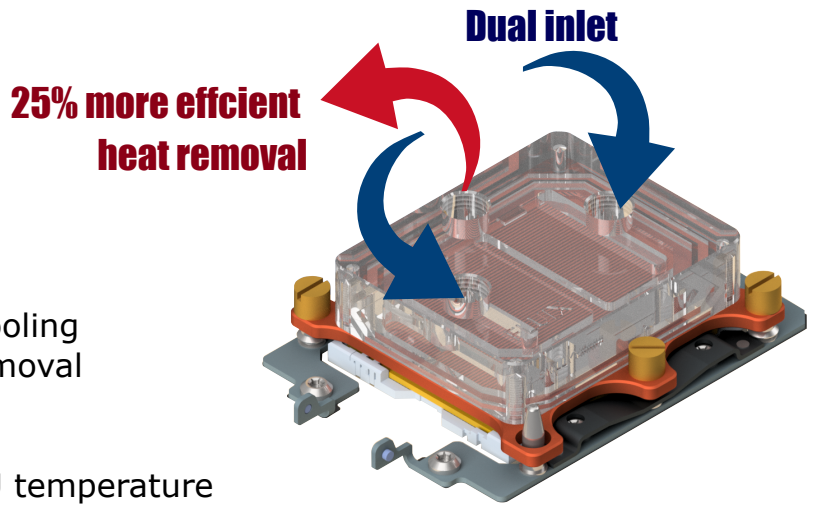
## INTEL XEON 3647

### FEATURES

- Patent Pending Turbulent Liquid Cooling technology for an efficient heat removal
- Lower CPU Temperature for Higher Sustained Processing Speed
  - No thermal throttling - low CPU temperature
  - 25% higher thermal headroom compared to conventional AIO liquid coolers
- Low Noise by fluid dynamic bearing 0.5 Sone at Max Power
- Highly configurable and easy to install
- Supports Intel LGA 3647 single and dual CPU
- 3 Year Warranty
- Money Back Guarantee if not satisfied with order within 30 days

### TECHNICAL SPECIFICATIONS

- Water Block Cold Plate Material: Copper
- Water Block Dimension: 91 x 87 x 22 mm
- Radiator Material: Copper
- Fan Max Speed: 2100 RPM
- Fan Static Pressure: 27 Pa
- Max Air Flow: 114.5 m<sup>3</sup>/h (per fan)
- Radiator & Fan Unit Dimension:
  - \* Optional 360 mm radiator  
391 x 120 x 70 mm
  - \* Optional 240 mm radiator  
271 x 120 x 70 mm
- Pump Max Flow Rate: 600 L/h
- Pump Max Pressure Head: 25.49 kPa
- Pump Unit Dimension: 62 x 60 x 48 mm
- Tubing Length:
  - Distance from Pump to Y-Splitter Inlet: 400 mm
  - Distance from Water Block to Radiator Unit: 560 mm
- Weight: 5.0 kg



SINGLE CPU



DUAL CPU

### SYSTEM REQUIREMENTS

- 4 Pin PWM Header
- Max Power: 8 W
- Voltage: DC 12 V

### MOUNTING KIT

- 4x M4-0.7 Mount Screws
- 8x Philip Head Screw M3-0.5 x 6 mm



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